Octal buffer/line driver; 3-state Rev. 6 — 2 July 2020

1. General description

The 74AHC244; 74AHCT244 is an 8-bit buffer/line driver with 3-state outputs. The device can be used as two 4-bit buffers or one 8-bit buffer. The device features two output enables ($1\overline{OE}$ and $2\overline{OE}$), each controlling four of the 3-state outputs. A HIGH on $n\overline{OE}$ causes the outputs to assume a high-impedance OFF-state. Inputs are overvoltage tolerant. This feature allows the use of these devices as translators in mixed voltage environments.

2. Features and benefits

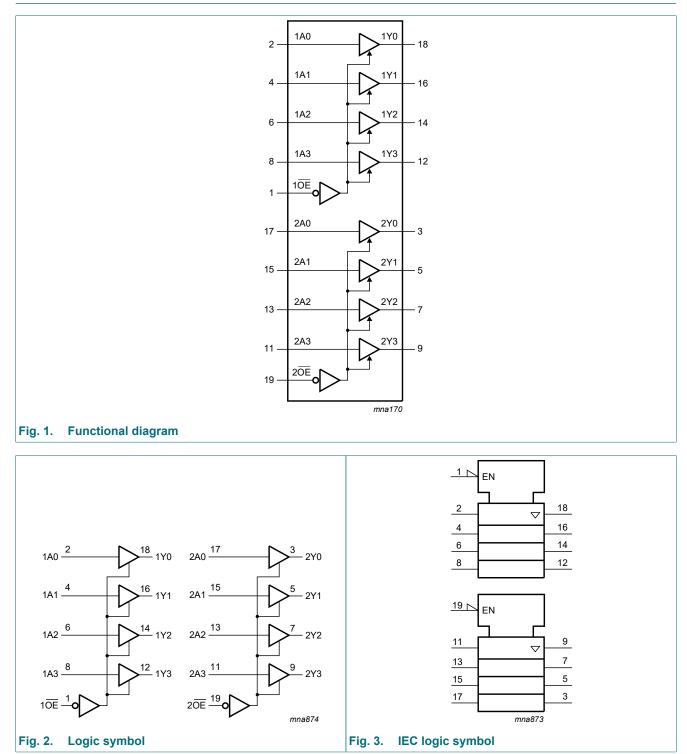
- Wide supply voltage range from 2.0 V to 5.5 V
- Balanced propagation delays
- All inputs have Schmitt-trigger action
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- Input levels:
 - For 74AHC244: CMOS level
 - For 74AHCT244: TTL level
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

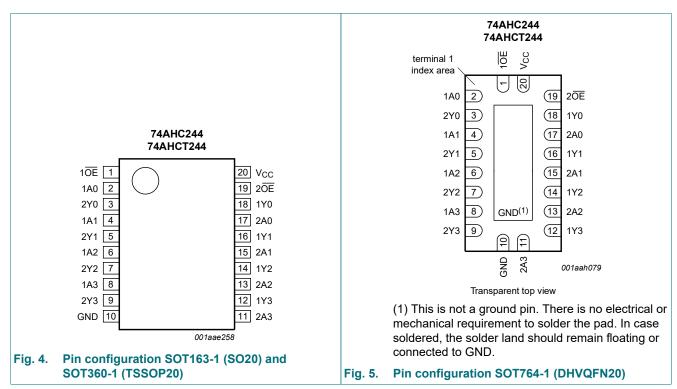
Table 1. Ordering info	ormation									
Type number	Package									
	Temperature range	Name	Description	Version						
74AHC244D	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1						
74AHCT244D			body width 7.5 mm							
74AHC244PW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package;	SOT360-1						
74AHCT244PW			20 leads; body width 4.4 mm							
74AHC244BQ	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal	SOT764-1						
74AHCT244BQ			enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm							

Octal buffer/line driver; 3-state

4. Functional diagram



5. Pinning information



5.1. Pinning

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
10E, 20E	1, 19	output enable input (active LOW)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2A0, 2A1, 2A2, 2A3	17, 15, 13, 11	data input
1Y0, 1Y1, 1Y2, 1Y3	18, 16, 14, 12	data output
2Y0, 2Y1, 2Y2, 2Y3	3, 5, 7, 9	data output
GND	10	ground (0 V)
V _{CC}	20	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

	Input	Output
nOE	nAn	nYn
L	L	L
	Н	Н
Н	x	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	[1]	-20	-	mA
I _{ОК}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	[1]	-	±20	mA
lo	output current	V_{O} = -0.5 V to V_{CC} + 0.5 V		-	±25	mA
I _{CC}	supply current			-	75	mA
I _{GND}	ground current			-75	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT163-1 (SO20) package: P_{tot} derates linearly with 12.3 mW/K above 109 °C.

For SOT360-1 (TSSOP20) package: Ptot derates linearly with 10.0 mW/K above 100 °C.

For SOT764-1 (DHVQFN20) package: P_{tot} derates linearly with 12.9 mW/K above 111 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter Conditions		74AHC244			74	Unit		
			Min	Тур	Max	Min	Тур	Мах	
V _{CC}	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and	V _{CC} = 3.3 V ± 0.3 V	-	-	100	-	-	-	ns/V
	fall rate	V _{CC} = 5.0 V ± 0.5 V	-	-	20	-	-	20	ns/V

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Мах	Min	Max	-
74AHC2	44	-								
VIH	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -50 μΑ; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -50 μΑ; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA; V _{CC} = 3.0 V	2.58	-	-	2.48	-	2.40	-	V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.94	-	-	3.8	-	3.70	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I _O = 8.0 mA; V _{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL};$ $V_{O} = V_{CC} \text{ or GND}; V_{CC} = 5.5 \text{ V}$	-	-	±0.25	-	±2.5	-	±10.0	μA
lı	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	4.0	-	40	-	80	μA
CI	input capacitance		-	3.0	10	-	10	-	10	pF
Co	output capacitance		-	4.0	-	-	-	-	-	pF

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74AHC244; 74AHCT244

Octal buffer/line driver; 3-state

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHCT	244						•	1		
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
VIL	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	l _O = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -8.0 mA	3.94	-	-	3.8	-	3.70	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		l _O = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL};$ $V_{O} = V_{CC} \text{ or GND}; V_{CC} = 5.5 \text{ V}$	-	-	±0.25	-	±2.5	-	±10.0	μA
l _l	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	4.0	-	40	-	80	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 V$; $I_O = 0 A$; other pins at V_{CC} or GND; $V_{CC} = 4.5 V$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance		-	3	10	-	10	-	10	pF
Co	output capacitance		-	4.0	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V. For test circuit see Fig. 8.

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	-40 °C t	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	1
74AHC2	44			1						
t _{pd}	propagation	nAn to nYn; see Fig. 6 [2]								
	delay	V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.0	8.4	1.0	10.0	1.0	10.5	ns
		C _L = 50 pF	-	7.0	11.9	1.0	13.5	1.0	15.0	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.4	5.5	1.0	6.5	1.0	7.0	ns
		C _L = 50 pF		5.0	7.5	1.0	8.5	1.0	9.5	ns
t _{en}	enable time	nOE to nYn; see Fig. 7 [2]								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	6.5	10.6	1.0	12.5	1.0	13.5	ns
		C _L = 50 pF	-	7.5	14.1	1.0	16.0	1.0	18.0	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	4.0	7.3	1.0	8.5	1.0	9.5	ns
		C _L = 50 pF	-	5.5	9.3	1.0	10.5	1.0	12.0	ns
t _{dis}	disable time	nOE to nYn; see Fig. 7 [2]								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.5	9.7	1.0	11.0	1.0	12.5	ns
		C _L = 50 pF	-	10.0	14.0	1.0	16.0	1.0	17.5	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	4.8	7.2	1.0	8.5	1.0	9.0	ns
		C _L = 50 pF	-	7.0	9.2	1.0	10.5	1.0	11.5	ns
C _{PD}	power dissipation capacitance	$C_{L} = 50 \text{ pF}; f_{i} = 1 \text{ MHz}; \qquad [3]$ V _I = GND to V _{CC}	-	10	-	-	-	-	-	pF

Octal buffer/line driver; 3-state

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	1
74AHCT	244	,								
t _{pd}	propagation	nAn to nYn; see Fig. 6 [2]								
	delay	V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.5	7.4	1.0	8.5	1.0	9.5	ns
		C _L = 50 pF	-	5.0	8.4	1.0	9.5	1.0	10.5	ns
t _{en}	enable time	n OE to nYn; see <u>Fig. 7</u>								
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.5	10.4	1.0	12.0	1.0	13.0	ns
		C _L = 50 pF	-	5.5	11.4	1.0	13.0	1.0	14.5	ns
t _{dis}	disable time	nOE to nYn; see Fig. 7 [2]								
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	5.0	9.4	1.0	10.0	1.0	12.0	ns
		C _L = 50 pF	-	7.0	11.4	1.0	13.0	1.0	14.5	ns
C _{PD}	power dissipation capacitance	$C_{L} = 50 \text{ pF; } f_{i} = 1 \text{ MHz;} $ [3] V _I = GND to V _{CC}	-	12	-	-	-	-	-	pF

 $t_{en} \mbox{ is the same as } t_{PZL} \mbox{ and } t_{PZH}.$

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] C_{PD} is used to determine the dynamic power dissipation $P_D (\mu W)$. $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

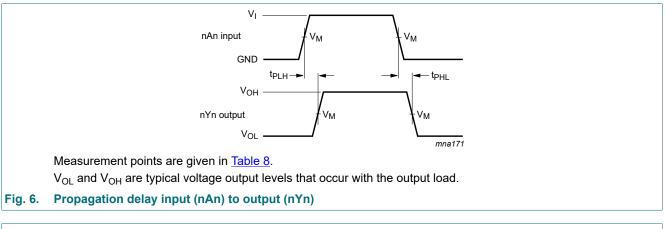
 f_i = input frequency in MHz;

f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in Volts.

Octal buffer/line driver; 3-state



10.1. Waveforms and test circuit

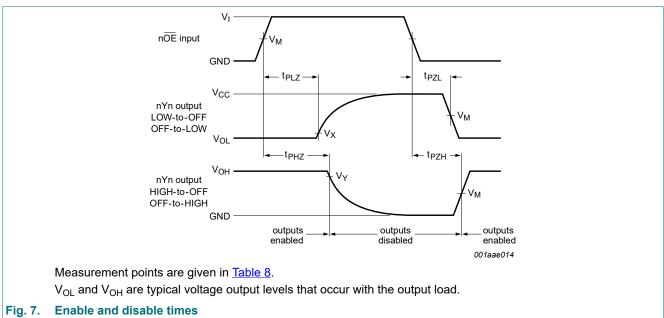


Table 8. Measurement points

Туре	Input	Output	Output				
	V _M	V _M	V _X	V _Y			
74AHC244	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} - 0.3 V			
74AHCT244	1.5 V	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} - 0.3 V			

Octal buffer/line driver; 3-state

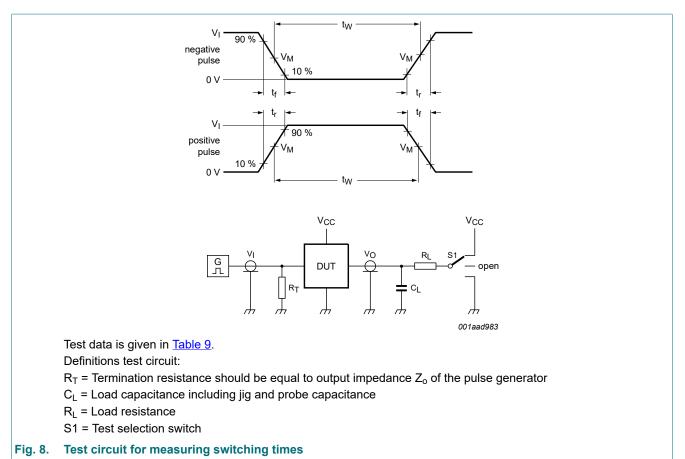


Table 9. Test data

Туре	Input		Load		S1 position		
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74AHC244	V _{CC}	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74AHCT244	3.0 V	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

Octal buffer/line driver; 3-state

11. Package outline

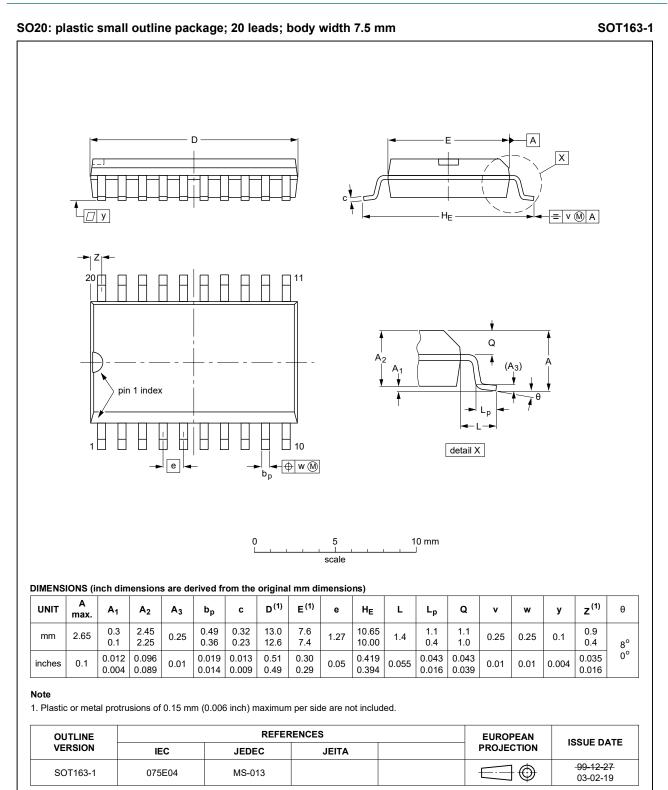


Fig. 9. Package outline SOT163-1 (SO20)

Octal buffer/line driver; 3-state

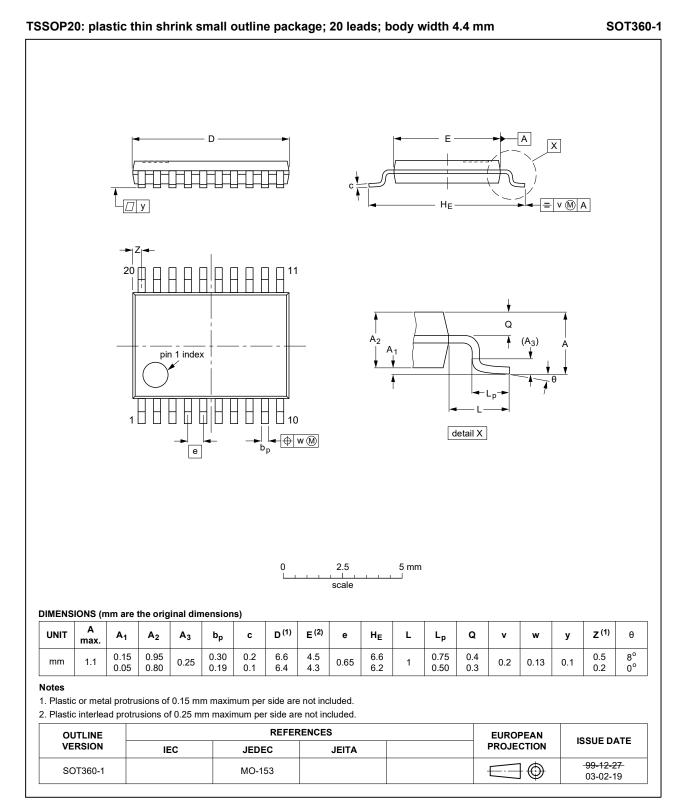
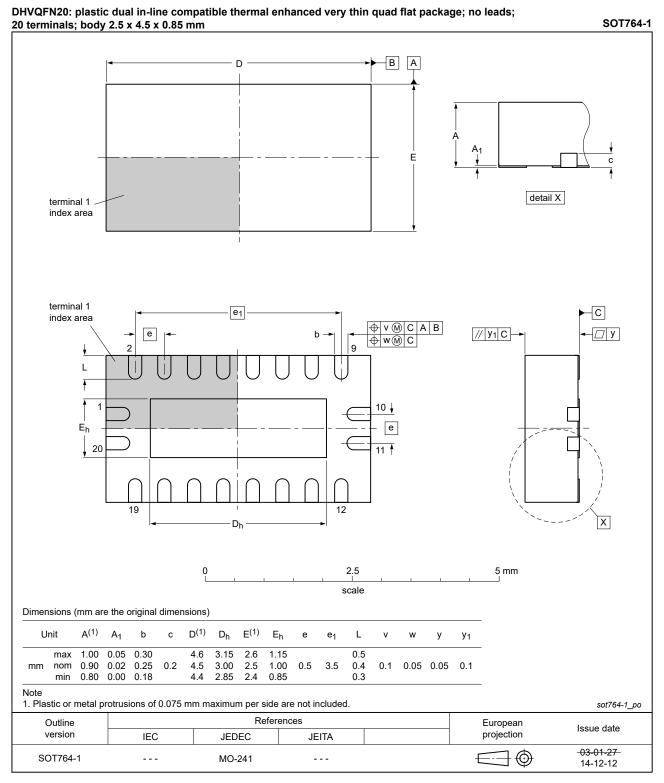


Fig. 10. Package outline SOT360-1 (TSSOP20)

Octal buffer/line driver; 3-state





12. Abbreviations

Acronym	Description
CDM	Charge Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AHC_AHCT244 v.6	20200702	Product data sheet	-	74AHC_AHCT244 v.5	
Modifications:	 Nexperia. Legal texts have be <u>Section 1</u> and <u>Section 1</u> <u>Table 4</u>: Derating 9 <u>Table 6</u>: Condition 	The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Section 1 and Section 2 updated. Table 4: Derating values for P _{tot} total power dissipation have been updated. Table 6: Conditions for I _{OZ} corrected. Package outline drawing of SOT764-1 (Fig. 11) updated.			
74AHC_AHCT244 v.5	20071220	Product data sheet	-	74AHC_AHCT244 v.4	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. <u>Section 3</u>: DHVQFN20 package added. <u>Section 7</u>: derating values added for DHVQFN20 package. <u>Section 11</u>: outline drawing added for DHVQFN20 package. 				
74AHC_AHCT244 v.4	20060210	Product data sheet	-	74AHC_AHCT244 v.3	
74AHC_AHCT244 v.3	19990928	Product specification	-	74AHC_AHCT244 v.2	
74AHC_AHCT244 v.2	19990224	Product specification	-	74AHC_AHCT244 v.1	
74AHC_AHCT244 v.1	19980921	Product specification	-	-	

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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Octal buffer/line driver; 3-state

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